

General Description

The MAX9951/MAX9952 dual parametric measurement units (PMUs) feature a small package size, wide force and measurement range, and high accuracy, making the devices ideal for automatic test equipment (ATE) and other instrumentation that requires a PMU per pin or per site.

The MAX9951/MAX9952 force or measure voltages in the -2V to +7V through -7V to +13V ranges, dependent upon the supply voltage (V_{CC} and V_{EE}). The devices handle supply voltages of up to +30V (VCC to VEE) and a 20V device-under-test (DUT) voltage swing at full current. The MAX9951/MAX9952 also force or measure currents up to ±64mA with a lowest full-scale range of ±2µA. Integrated support circuitry facilitates use of an external buffer amplifier for current ranges greater than ±64mA.

A voltage proportional to the measured output voltage or current is provided at the MSR_ output. Integrated comparators, with externally set voltage thresholds, provide detection for both voltage and current levels. The MSR_ and comparator outputs can be placed in a high-impedance state. Separate FORCE and SENSE connections are short-circuit protected for voltages from (VEE - 0.3V) to (VCC + 0.3V). The FORCE output also features a low-leakage, high-impedance state.

Integrated voltage clamps limit the force output to levels set externally. The force-current or the measure-current voltage can be offset -0.2V to +4.4V (IOS). This feature allows for the centering of the control or measured signal within the external DAC or ADC range.

The MAX9951D/MAX9952D feature an integrated $10k\Omega$ force-sense resistor between FORCE_ and SENSE_. The MAX9951F/MAX9952F have no internal force-sense resistor. These devices are available in a 64-pin, 10mm x 10mm, 0.5mm pitch TQFP package with an exposed 8mm x 8mm die pad on the top (MAX9951) or the bottom (MAX9952) of the package for efficient heat removal. The exposed pad is internally connected to VEE. The MAX9951/MAX9952 are specified over the commercial 0°C to +70°C temperature range.

Applications

Memory Testers VLSI Testers System-on-a-Chip Testers Structural Testers

Features

- **♦** Force Voltage/Measure Current (FVMI)
- **♦** Force Current/Measure Voltage (FIMV)
- **♦** Force Voltage/Measure Voltage (FVMV)
- ♦ Force Current/Measure Current (FIMI)
- **♦** Force Nothing/Measure Voltage (FNMV)
- **♦** Force Nothing/Measure Current (FNMI, Range E Only)
- ◆ Termination/Measure Current
- ♦ Termination/Measure Voltage
- ♦ Five Programmable Current Ranges
 - ±2uA
 - ±20µA
 - ±200µA
 - ±2mÅ
 - ±64mA
- ◆ -2V to +7V Through -7V to +13V Input-Voltage Range
- ♦ Force-Current/Measure-Current Adjustable-Voltage Offset (IOS)
- ♦ Programmable Voltage Clamps at Force Output
- ◆ Low-Leakage, High-Impedance Measure, and **Force States**
- ♦ 3-Wire Serial Interface
- ♦ Low 6mA (max) Quiescent Current per PMU

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX9951DCCB	0°C to +70°C	64 TQFP-EPR
MAX9951FCCB*	0°C to +70°C	64 TQFP-EPR
MAX9952DCCB	0°C to +70°C	64 TQFP-EP
MAX9952FCCB*	0°C to +70°C	64 TQFP-EP

^{*}Future product—contact factory for availability.

Selector Guide

PART	DESCRIPTION
MAX9951DCCB	Internal 10k Ω force-sense resistor
MAX9951FCCB	External force-sense resistor
MAX9952DCCB	Internal $10k\Omega$ force-sense resistor
MAX9952FCCB	External force-sense resistor

Pin Configurations appear at end of data sheet.



ABSOLUTE MAXIMUM RATINGS

V _{CC} to AGND	+20V
VEE to AGND	15V
V _{CC} to V _{EE}	+32V
V _L to AGND	+6V
AGND to DGND0.5V t	io +0.5V
Digital Inputs/Outputs0.3V to (VL	+ 0.3V)
All Other Pins to AGND(VEE - 0.3V) to (VCC	+ 0.3V
Continuous Power Dissipation (T _A = +70°C)	
MAX9951_CCB (derate 43.5mW/°C above +70°C)3	3478mW
MAX9952_CCB (derate 125mW/°C above +70°C)10	,000mW

θ _{JA} MAX9951_CCB	+8°C/W
θ _{JC} MAX9951_CCB	+2°C/W
θ _{JA} MAX9952_CCB	+23°C/W
θ _{JC} MAX9952_CCB	+8°C/W
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Operating Temperature Range (commercial	
Lead Temperature (soldering 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +12V, V_{EE} = -7V, V_L = +3.3V, T_A = +25^{\circ}C, unless otherwise noted.$ Specifications at $T_A = T_{MIN}$ and $T_A = T_{MAX}$ are guaranteed by design and characterization. Typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
FORCE VOLTAGE							
Force Input Voltage Range	V _{INO_} , V _{IN1_}			VEE + 2.5		V _{CC} - 2.5	V
		DUT current at full scale	$V_{CC} = +12V, V_{EE} = -7V$	-2		+7	
Forced Voltage	V _{DUT}	DOT Current at full scale	$V_{CC} = +18V, V_{EE} = -12V$	-7		+13	V
		DUT current = 0		V _{EE} + 2.5		V _{CC} - 2.5	
Input Bias Current					±1		μΑ
Forced-Voltage Offset	V _{FOS}			-25		+25	mV
Forced-Voltage-Offset Temperature Coefficient					±100		μV/°C
Forced-Voltage Gain Error	VFGE	Nominal gain of +1		-1	0.005	+1	%
Forced-Voltage-Gain Temperature Coefficient					±10		ppm/°C
Forced-Voltage Linearity Error	VFLER	Gain and offset errors ca	librated out (Notes 2, 3)	-0.02		+0.02	%FSR
MEASURE CURRENT							
Measure-Current Offset	I _{MOS}	(Note 2)		-1		+1	%FSR
Measure-Current-Offset Temperature Coefficient					±20		ppm/°C
Measure-Current Gain Error	IMGE	(Note 4)		-1		+1	%
Measure-Current-Gain Temperature Coefficient					±20		ppm/°C
Linearity Error	I _{MLER}	Gain and offset errors ca (Notes 2, 3, 5)	llibrated out	-0.02		+0.02	%FSR

DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +12V, V_{EE} = -7V, V_L = +3.3V, T_A = +25^{\circ}C, unless otherwise noted. Specifications at T_A = T_{MIN} and T_A = T_{MAX}$ are guaranteed by design and characterization. Typical values are at $T_A = +25^{\circ}C, unless$ otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Measure-Output-Voltage		VIOS_ = VDUTGND	-4		+4	.,
Range Over Full-Current Range	VMSR	V _{IOS} _ = 4V + V _{DUTGND}	0		+8	V
Current-Sense Amp Offset-Voltage Input	V _{IOS}	Relative to V _{DUTGND}	-0.2		+4.4	V
Rejection of Output- Measure Error Due to Common-Mode Sense Voltage	CMVR _{LER}	(Notes 4 and 6)		+0.001	+0.007	%FSR/V
		Range E, R_E = $500k\Omega$	-2		+2	
		Range D, R_D = $50k\Omega$	-20		+20	μΑ
Measure-Current Range		Range C, R_C = $5k\Omega$	-200		+200	
		Range B, R_B = 500Ω	-2		+2	mA
		Range A, R_A = 15.6Ω	-64		+64	mA
FORCE CURRENT						
Input Voltage Range for Setting Forced Current	V _{INO_} ,	V _{IOS} _ = V _{DUTGND}	-4		+4	V
Over Full Range	V _{IN1} _	V _{IOS} _ = 4V + V _{DUTGND}	0		+8	V
Current-Sense Amp Offset-Voltage Input	V _{IOS}	Relative to V _{DUTGND}	-0.2		+4.4	V
IOS_ Input Bias Current				±1		μΑ
Forced-Current Offset		(Note 2)	-1		+1	%FSR
Forced-Current-Offset Temperature Coefficient				±20		ppm/°C
Forced-Current Gain Error		(Note 4)	-1		+1	%
Forced-Current-Gain Temperature Coefficient				±20		ppm/°C
Forced-Current Linearity Error	IFLER	Gain and offset errors calibrated out (Notes 2, 3, 5)	-0.02		+0.02	%FSR
Rejection of Output Error Due to Common-Mode Load Voltage	CMRIOER	(Notes 4 and 6)		+0.001	+0.007	%FSR/V
		Range E, R_E = $500k\Omega$	-2		+2	
		Range D, R_D = $50k\Omega$	-20		+20	μΑ
Forced-Current Range		Range C, R_C = $5k\Omega$	-200		+200	1
		Range B, R_B = 500Ω	-2		+2	nc ^
		Range A, R_A = 15.6Ω	-64		+64	mA

DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +12V, V_{EE} = -7V, V_L = +3.3V, T_A = +25^{\circ}C, unless otherwise noted.$ Specifications at $T_A = T_{MIN}$ and $T_A = T_{MAX}$ are guaranteed by design and characterization. Typical values are at $T_A = +25^{\circ}C, unless$ otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
MEASURE VOLTAGE								
Measure-Voltage-Offset	V _{MOS}			-25		+25	mV	
Measure-Voltage-Offset Temperature Coefficient					±100		μV/°C	
Gain Error	VMGER	Nominal gain of +1		-1	±0.005	+1	%	
Measure-Voltage-Gain Temperature Coefficient					±10		ppm/°C	
Measure-Voltage Linearity Error	VMLER	Gain and offset errors ca (Notes 2, 3, 5)	librated out	-0.02		+0.02	%FSR	
Measure-Output-Voltage		DUT current at full scale	$V_{CC} = +12V, V_{EE} = -7V$	-2		+7		
Range Over Full DUT	VMSR	DOT Current at full scale	$V_{CC} = +18V, V_{EE} = -12V$	-7		+13	V	
Voltage		DUT current = 0		V _{EE} + 2.5		V _{CC} - 2.5		
FORCE OUTPUT								
Off-State Leakage Current				-1		+1	nA	
Short-Circuit Current	I _{LIM} -			-92		-65		
Limit	I _{LIM+}			+65		+92	mA	
Force-to-Sense Resistor	RFS	D option only		8	10	12	kΩ	
SENSE INPUT								
Input Voltage Range				V _{EE} + 2.5		V _{CC} - 2.5	V	
Leakage Current		F option only		-1		+1	nA	
COMPARATOR INPUTS								
Input Voltage Range				V _{EE} + 2.5		V _{CC} - 2.5	V	
Offset Voltage				-25		+25	mV	
Input Bias Current					±1		μΑ	
VOLTAGE CLAMPS								
Input Control Voltage	V _{CLLO_} , V _{CLHI_}			V _{EE} + 2.4		V _{CC} - 2.4	V	
Clamp Voltage Accuracy		(Note 7)		-100		+100	mV	
DIGITAL INPUTS	•			•				
		V _L = 5V		+3.5				
Input High Voltage (Note 8)	VIH	V _L = 3.3V		+2.0			v	
		V _L = 2.5V		+1.7				
Input Low Voltage		$V_L = 5V \text{ or } 3.3V$				+0.8	\/	
(Note 8)	VIL	$V_L = 2.5V$				+0.7	V	
Input Current	I _{IN}				±1		μΑ	
Input Capacitance	C _{IN}		<u> </u>		3.0	<u> </u>	рF	

DC ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +12V, V_{EE} = -7V, V_L = +3.3V, T_A = +25^{\circ}C, unless otherwise noted.$ Specifications at $T_A = T_{MIN}$ and $T_A = T_{MAX}$ are guaranteed by design and characterization. Typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
COMPARATOR OUTPUT	S					
Output High Voltage	VoH	$V_L = +2.375V \text{ to } +5.5V, R_{PUP} = 1k\Omega$	V _L - 0.2			V
Output Low Voltage	V _{OL}	$V_L = +2.375V \text{ to } +5.5V, R_{PUP} = 1k\Omega$			+0.4	V
High-Impedance-State Leakage Current				±1		μΑ
High-Impedance-State Output Capacitance				6.0		pF
DIGITAL OUTPUTS	•		•			•
Output High Voltage	Voh	$I_{OUT} = 1$ mA, $V_L = +2.375$ V to $+5.5$ V, relative to DGND	V _L - 0.25			V
Output Low Voltage	V _{OL}	I_{OUT} = -1mA, V_L = +2.375V to +5.5V, relative to DGND			+0.2	V
POWER SUPPLY			•			
Positive Supply	Vcc	(Note 1)	+10	+12	+18	V
Negative Supply	VEE	(Note 1)	-15	-7	-5	V
Total Supply Voltage	V _{CC} - V _{EE}	(Note 9)			+30	V
Logic Supply	VL		+2.375		+5.5	V
Positive Supply Current	Icc	No load, clamps enabled			10.0	mA
Negative Supply Current	I _{EE}	No load, clamps enabled			10.0	mA
Logic Supply Current	ΙL	No load, all digital inputs at rails			1.2	mA
Analog Ground Current	IAGND	No load, clamps enabled		0.9		mA
Digital Ground Current	IDGND	No load, all digital inputs at rails		1.4		mA
Power-Supply Rejection	PSRR	1MHz, measured at force output		20		dB
Ratio	1 01111	60Hz, measured at force output		85		GD

AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +12V, V_{EE} = -7V, V_L = +3.3V, C_{CM} = 120pF, C_L = 100pF, T_A = +25^{\circ}C, unless otherwise noted. Specifications at T_A = T_{MIN}$ and $T_A = T_{MAX}$ are guaranteed by design and characterization. Typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
FORCE VOLTAGE (Notes	s 10, 11)					
		Range E, R_E = $500k\Omega$		150		
		Range D, R_D = $50k\Omega$		50		
Settling Time		Range C, R_C = $5k\Omega$		20	30	μs
		Range B, R_B = 500Ω		20		
		Range A, R_A = 15.6Ω		25		
FORCE VOLTAGE/MEAS	URE CURF	RENT (Notes 10, 11)				
		Range E, R_E = $500k\Omega$		500		
		Range D, R_D = $50k\Omega$		100		1
Settling Time		Range C, R_C = $5k\Omega$		30	55	μs
		Range B, R_B = 500Ω		25		
		Range A, R_A = 15.6Ω		25		
Range Change Switching		In addition to force-voltage and measure-current settling times, range A to range B, R_A = 15.6 Ω , R_B = 500 Ω		12		μs
FORCE CURRENT/MEAS	SURE VOLT	FAGE (Notes 10, 11)				•
		Range E, R_E = $500k\Omega$		2500		
		Range D, R_D = $50k\Omega$		350		
Settling Time		Range C, R_C = $5k\Omega$		30	60	μs
		Range B, R_B = 500Ω		25]
		Range A, R_A = 15.6Ω		25		1
Range Change Switching		In addition to force-current and measure-voltage settling times, range A to range B, R_A = 15.6 Ω , R_B = 500 Ω		12		μs
SENSE INPUT TO MEAS	URE OUTP	UT PATH				•
Propagation Delay		C _{LMSR} = 100pF		0.2		μs
MEASURE OUTPUT						
Maximum Stable Load Capacitance			1000			pF
COMPARATORS (CLCON	_{1P} = 20pF, F	$R_{\text{PUP}} = 1 \text{k}\Omega$)				•
Propagation Delay		50mV overdrive, 1V _{P-P} , measured from input- threshold zero crossing to 50% of output voltage (Note 12)		75		ns
Rise Time		20% to 80%		60		ns
Fall Time		80% to 20%		5		ns
SERIAL PORT (V _L = +3.3	V, C _{DOUT} =	= 10pF)				-
Serial Clock Frequency	fsclk	(Note 13)			20	MHz
SCLK Pulse-Width High	tсн		12			ns
SCLK Pulse-Width Low	t _{CL}		12			ns

MIXIM

AC ELECTRICAL CHARACTERISTICS (continued)

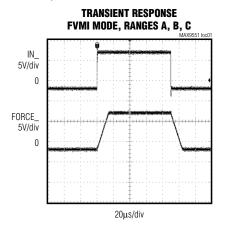
 $(V_{CC} = +12V, V_{EE} = -7V, V_{L} = +3.3V, C_{CM} = 120pF, C_{L} = 100pF, T_{A} = +25^{\circ}C, unless otherwise noted. Specifications at T_{A} = T_{MIN}$ and $T_{A} = T_{MAX}$ are guaranteed by design and characterization. Typical values are at $T_{A} = +25^{\circ}C$, unless otherwise noted.) (Note 1)

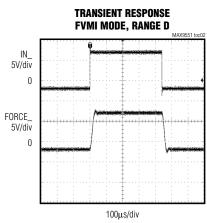
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SCLK Fall to DOUT Valid	t _{DO}				22	ns
CS Low to SCLK High Setup	tcsso		10			ns
SCLK High to $\overline{\text{CS}}$ High Hold	tCSH1		22			ns
SCLK High to $\overline{\text{CS}}$ Low Hold	tCSH0		0			ns
CS High to SCLK High Setup	tCSS1		5			ns
DIN to SCLK High Setup	t _{DS}		10			ns
DIN to SCLK High Hold	tDH	(Note 12)	0			ns
CS Pulse-Width High	tcswh		10			ns
CS Pulse-Width Low	tcswl		10			ns
LOAD Pulse-Width Low	t _{LDW}		20			ns
V _{DD} High to $\overline{\text{CS}}$ Low (Power-Up)		(Note 12)			500	ns

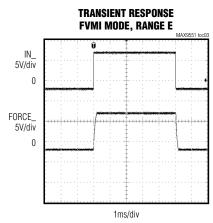
- **Note 1:** The device operates properly with different supply voltages with equally different voltage swings.
- Note 2: Interpret errors expressed in terms of %FSR (percent of full-scale range) as a percentage of the end-point-to-end-point range, i.e., for the ±64mA range, the full-scale range = 128mA, and a 1% error = 1.28mA.
- **Note 3:** Case must be maintained ±5°C for linearity specifications.
- Note 4: Tested in range C.
- Note 5: Current linearity specifications are maintained to within 700mV of the clamp voltages when the clamps are enabled.
- Note 6: Specified as the percent of full-scale range change at the output per volt change in the DUT voltage.
- **Note 7:** VCIIO and VCIHI should differ by at least 700mV.
- Note 8: The digital interface accepts +5V, +3.3V, and +2.5V CMOS logic levels. The voltage at V_L adjusts the threshold.
- Note 9: Guaranteed by design.
- Note 10: Settling times are to 0.1% of FSR. Cx_ = 60pF.
- **Note 11:** All settling times are specified using a single compensation capacitor (Cx_) across all current-sense resistors. Use an individual capacitor across each sense resistor for better performance across all current ranges, particularly the lower ranges.
- **Note 12:** The propagation delay time is only guaranteed over the force-voltage output range. Propagation delay is measured by holding V_{SENSE} steady and transitioning THMAX_ or THMIN_.
- **Note 13:** Maximum serial clock frequency may diminish at $V_L < +3.3V$.

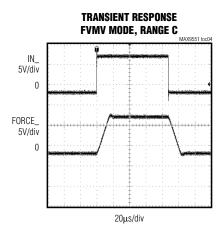
Typical Operating Characteristics

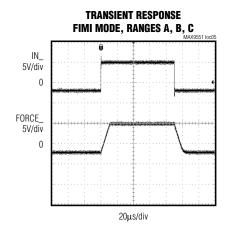
 $(V_{CC} = +12V, V_{EE} = -7V, C_L = 100pF, C_{CM} = 120pF, C_{CX} = 60pF, R_L to +2.5V, range A: R_A = 15.6\Omega, R_L = 70.3\Omega; range B: R_B = 500\Omega, R_L = 2.25k\Omega; range C: R_C = 5k\Omega, R_L = 22.5k\Omega; range D: R_D = 50k\Omega, R_L = 225k\Omega; range E: R_E = 500k\Omega, R_L = 2.25M\Omega, T_A = +25°C.)$

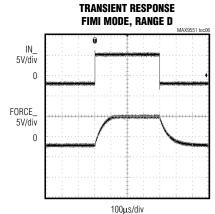


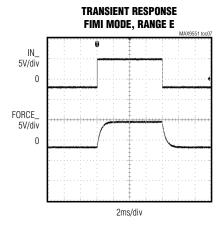


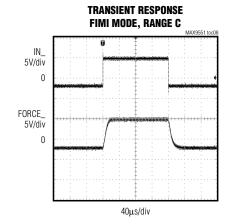


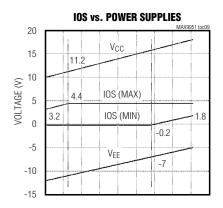












Pin Description

PIN			
MAX9951	MAX9952	NAME	FUNCTION
1	48	SENSEA	PMU-A Sense Input. A Kelvin connection to the DUT. Provides the feedback signal in FVMI mode and the measured signal in FIMV mode for PMU-A.
2	47	FORCEA	PMU-A Driver Output. Forces a current or voltage to the DUT for PMU-A.
3	46	CCA	PMU-A Compensation Capacitor Connection. Provides compensation for the PMU-A main amplifier. Connect a 120pF capacitor from CCA to CCOMA.
5, 15, 34, 44	5, 15, 34, 44	VEE	Negative Analog-Supply Input
4, 14, 35, 45	4, 14, 35, 45	Vcc	Positive Analog-Supply Input
6	43	CCOMA	Common Connection of CMA and CXA for PMU-A
7	42	RAAS	PMU-A Range Setting Resistor-Sense Connection
8	41	RAA	PMU-A Range A Setting Resistor Connection
9	40	RAB	PMU-A Range B Setting Resistor Connection
10	39	RAC	PMU-A Range C Setting Resistor Connection
11	38	RAD	PMU-A Range D Setting Resistor Connection
12	37	RAE	PMU-A Range E Setting Resistor Connection
13	36	RAX	PMU-A Current-Range Sense-Resistor Connection. Connects to the external current range sense resistor for PMU-A.
16	33	EXTSELA	PMU-A External Current-Range Selector. Selects the external current range for PMU-A.
17	32	DUTLA	PMU-A Window Comparator Lower Comparator Output. A high output indicates that the sensed voltage at the window comparator is above V _{THMINA} . DUTLA is an open-drain output.
18	31	DUTHA	PMU-A Window Comparator Higher Comparator Output. A high output indicates that the sensed voltage at the window comparator is below V _{THMAXA} . DUTHA is an open-drain output.
19	30	HI-ZA	MSRA Tri-State Control Input. A logic-low places MSRA in a high-impedance state.
20	29	INSELA	Input Select PMU-A. INSELA is a logic input that selects between INOA and IN1A. Force INSELA low to select INOA. INSELA is NANDed with control register bit INMODEA.
21	28	TEMP	Temperature Output. V _{TEMP} = 10mV/°C. T _{DIE} (°C) = (100)V _{TEMP} - 273.
22	27	DGND	Digital Ground
23	26	VL	Logic-Supply Voltage Input. The voltage applied at V _L sets the upper logic-voltage level.
24	25	DOUT	Serial-Data Output. A standard SPI™-compatible output. Data appears at DOUT MSB first.
25	24	DIN	Serial-Data Input. Load data into DIN MSB first.
26	23	LOAD	Serial-Port Load Input. A logic-low asynchronously loads data from the input registers into the PMU registers.

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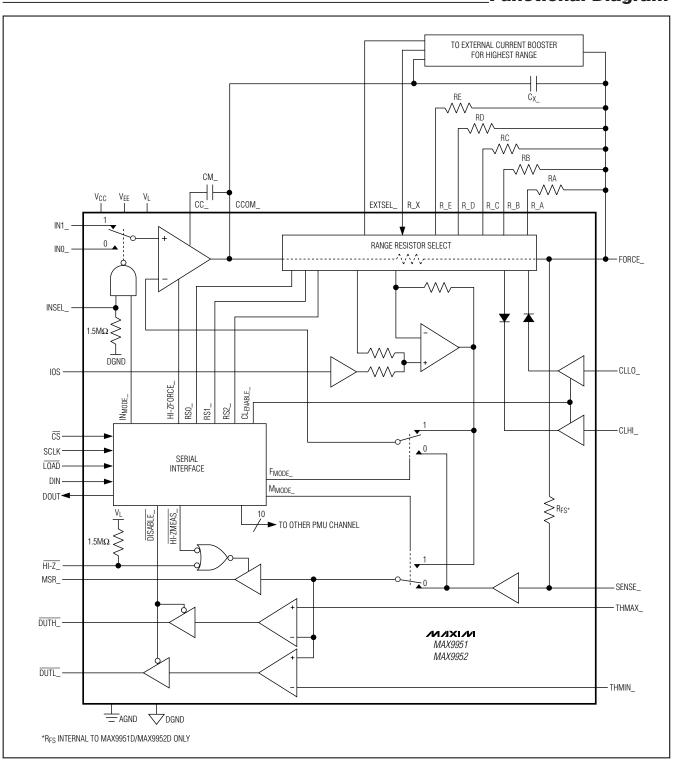
Pin Description (continued)

PIN			
MAX9951	MAX9952	NAME	FUNCTION
27	22	SCLK	Serial-Clock Input. SCLK accepts external clock frequencies up to 20MHz.
28	21	CS	Chip-Select Input. Force $\overline{\text{CS}}$ low to enable the serial interface.
29	20	INSELB	Input Select PMU-B. INSELB is a logic input that selects between IN0B and IN1B. Force INSELB low to select IN0B. INSELB is NANDed with control register bit INMODEB.
30	19	HI-ZB	MSRB Tri-State Control Input. A logic-low places MSRB in a high-impedance state.
31	18	DUTHB	PMU-B Window Comparator Higher Comparator Output. A high output indicates that the sensed voltage at the window comparator is below V _{THMAXB} . DUTHB is an open-drain output.
32	17	DUTLB	PMU-B Window Comparator Lower Comparator Output. A high output indicates that the sensed voltage at the window comparator is above V _{THMINB} . DUTLB is an open-drain output.
33	16	EXTSELB	PMU-B External Current-Range Selector. Selects the external current range for PMU-B.
36	13	RBX	PMU-B Current-Range Sense-Resistor Connection. Connects to the external current-range sense resistor for PMU-B.
37	12	RBE	PMU-B Range E Setting Resistor Connection
38	11	RBD	PMU-B Range D Setting Resistor Connection
39	10	RBC	PMU-B Range C Setting Resistor Connection
40	9	RBB	PMU-B Range B Setting Resistor Connection
41	8	RBA	PMU-B Range A Setting Resistor Connection
42	7	RBAS	PMU-B Range A Setting Resistor-Sense Connection
43	6	CCOMB	Common Connection of CMB and CXB for PMU-B
46	3	CCB	PMU-B Compensation Capacitor Connection. Provides compensation for the PMU-B main amplifier. Connect a 120pF capacitor from CCB to CCOMB.
47	2	FORCEB	PMU-B Driver Output. Forces a current or voltage to the DUT for PMU-B.
48	1	SENSEB	PMU-B Sense Input. A Kelvin connection to the DUT. Provides the feedback signal in FVMI mode and the measured signal in FIMV mode for PMU-B.
49	64	THMAXB	PMU-B Window Comparator Upper Threshold Voltage Input. Sets the upper voltage threshold for the PMU-B window comparator.
50	63	THMINB	PMU-B Window Comparator Lower Threshold Voltage Input. Sets the lower voltage threshold for the PMU-B window comparator.
51	62	CLHIB	PMU-B Upper-Clamp Voltage Input. Sets the upper-clamp voltage level.
52	61	CLLOB	PMU-B Lower-Clamp Voltage Input. Sets the lower-clamp voltage level.
53	60	IN0B	Force-Threshold Current Input for PMU-B. Sets the forced voltage in FV mode or the forced current in FI mode.
54	59	IN1B	Force-Threshold Voltage Input for PMU-B. Sets the forced voltage in FV mode or the forced current in FI mode

Pin Description (continued)

PIN		NAME	FUNCTION		
MAX9951	MAX9952	NAME	FONCTION		
55	58	MSRB	PMU-B Measurement Output. Provides a voltage equal to the SENSE voltage in FIMV mode, and provides a voltage proportional to the DUT current in FVMI mode for PMU-B. Force HI-ZB low to place MSRB in a high-impedance state.		
56	57	AGND	Analog Ground		
57	56	IOS	Offset-Voltage Input. Sets an offset voltage for the internal current-sense amplifiers of both channels.		
58	55	MSRA	PMU-A Measurement Output. Provides a voltage equal to the SENSE voltage in FIMV mode, and provides a voltage proportional to the DUT current in FVMI mode for PMU-A. Force HI-ZA low to place MSRA in a high-impedance state.		
59	54	IN1A	Force-Threshold Voltage Input for PMU-A. Sets the forced voltage in FV mode or the forced current in FI mode.		
60	53	IN0A	Force-Threshold Current Input for PMU-A. Sets the forced voltage in FV mode or the forced current in FI mode.		
61	52	CLLOA	PMU-A Lower-Clamp Voltage Input. Sets the lower-clamp voltage level.		
62	51	CLHIA	PMU-A Upper-Clamp Voltage Input. Sets the upper-clamp voltage level.		
63	50	THMINA	PMU-A Window Comparator Lower Threshold Voltage Input. Sets the lower voltage threshold for the PMU-A window comparator.		
64	49	THMAXA	PMU-A Window Comparator Upper Threshold Voltage Input. Sets the upper voltage threshold for the PMU-A window comparator.		

Functional Diagram



Detailed Description

The MAX9951/MAX9952 force or measure voltages in the -2V to +7V through -7V to +13V ranges, dependent upon the supply voltage range (VCC and VEE). These devices also force or measure currents up to ± 64 mA, with a lowest full-scale range of $\pm 2\mu$ A. Use an external buffer amplifier for current ranges greater than ± 64 mA.

MSR_ presents a voltage proportional to the measured voltage or current. Place MSR_ in a low-leakage, high-impedance state by forcing HI-Z_ low. Integrated comparators with externally programmable voltage thresholds provide "too low" (DUTL_) and "too high" (DUTH_) voltage-monitoring outputs. Each comparator output features a selectable high-impedance state. The devices feature separate FORCE_ and SENSE_ connections and are fully protected against short circuits. The FORCE_ output has two voltage clamps, negative (CLLO_) and positive (CLHI_), to limit the voltage to externally provided levels. Two control-voltage inputs, selected independently of the PMU mode, allow for greater flexibility.

Serial Interface

The MAX9951/MAX9952 use a standard 3-wire SPI/QSPI™/MICROWIRE™-compatible serial port. Once the input data register fills, the data becomes available at DOUT MSB first. This data output allows for daisy-chaining multiple devices. Figures 1, 2, and 3 show the serial interface timing diagrams.

Serial Port Operation

The serial interface has two ranks (Figure 4). Each PMU has an input register that loads from the serial port shift register. Each PMU also has a PMU register that loads from the input register. Data does not affect the PMU until it reaches the PMU register. This register configuration permits loading of the PMU data into the input register at one time and then latching the input register data into the PMU register later, at which time the PMU function changes accordingly. The register configuration also provides the ability to change the state of the PMU asynchronously, with respect to the loading of that PMU's data into the serial port. Thus, the PMU easily updates simultaneously with other PMUs or other devices.

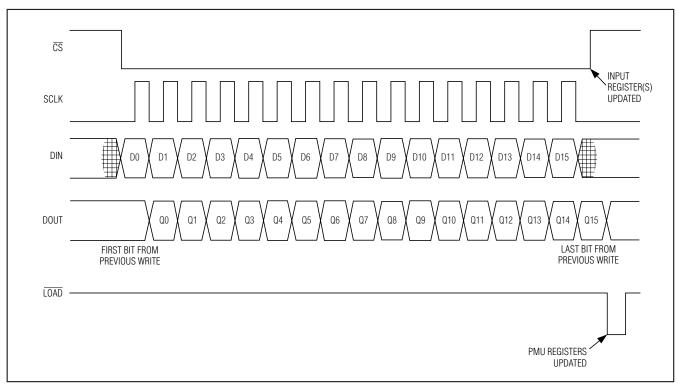


Figure 1. Serial Port Timing with Asynchronous Load

QSPI is a trademark of Motorola, Inc.
MICROWIRE is a trademark of National Semiconductor Corp.



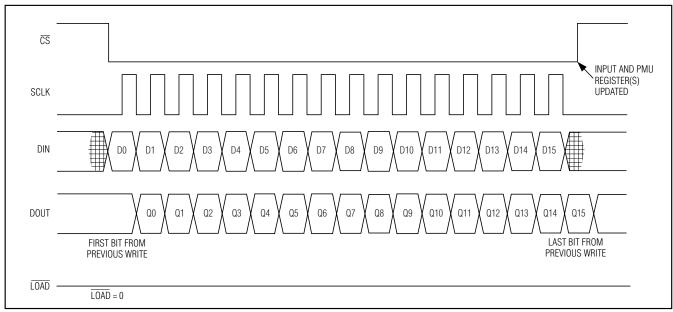


Figure 2. Serial Port Timing with Synchronous Load

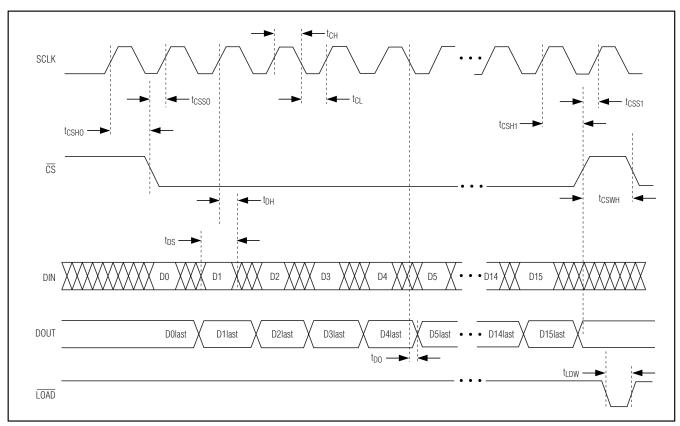


Figure 3. Detailed Serial Port Timing Diagram

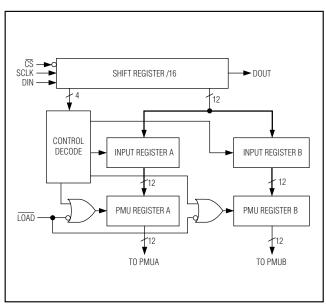


Figure 4. Dual PMU Serial Port Block Diagram

Use $\overline{\text{LOAD}}$ to asynchronously load all input registers into the PMU registers. If $\overline{\text{LOAD}}$ remains low when data latches into an input register, the data also transfers to the PMU register.

Bit Order

The MAX9951/MAX9952 use the bit order, MSB first in and first out, as shown in Table 1.

PMU Control

Programming both PMUs with the same data requires a 16-bit word. Programming each PMU with separate data requires two 16-bit words.

The address bits specify which input registers the shiftregister loads. Table 2 describes the function of the address bits.

Bits C1 and C2 specify how the data loads into the second rank PMU registers. These 2 control bits serve a similar function as the $\overline{\text{LOAD}}$ input. The specified actions occur when $\overline{\text{CS}}$ goes high, whereas the $\overline{\text{LOAD}}$ input loads the PMU register at anytime. When either C1 or C2 is low, the corresponding PMU register is transparent. Table 3 describes the function of the 2 control bits.

The NOP operation requires A1 = A2 = C1 = C2 = 0. In this case, the data transfers through the shift register without changing the state of the device.

Table 1. Bit Order

BIT	BIT NAME
15 (MSB)	INMODE
14	FMODE
13	MMODE
12	RS2
11	RS1
10	RS0
9	CLENABLE
8	HI-ZFORCE
7	HI-ZMSR
6	DISABLE
5	B2
4	B1
3	A2
2	A1
1	C2
0 (LSB)	C1

Table 2. Address Bit

(BIT 3) A2	(BIT 2) A1	OPERATION		
0	0	Do not update any input register (NOP).		
0	1	Only update input register A.		
1	0	Only update input register B.		
1	1	Update both input registers with the same data.		

Table 3. Control Bit

(BIT 1) C2	(BIT 0) C1	OPERATION	
0	0	Data stays in input register.	
0	1	Transfer PMU-A input register to PMU register.	
1	0	Transfer PMU-B input register to PMU register.	
1	1	Transfer both input registers to the PMU registers.	

C1 = C2 = 0 allows for data transfer from the shift register to the input register without transferring data to the PMU register (unless $\overline{\text{LOAD}}$ is low). This permits the latching of data into the PMU register at a later time by $\overline{\text{LOAD}}$ or subsequent command. Table 4 summarizes the possible control and address bit combinations. When asynchronously latching only one PMU's data, the input register of the other PMU maintains the same data. Therefore, loading both PMU registers would update the one PMU with new data while the other PMU remains in its current state.

Mode Selection

Four bits from the control word select between the various force-measure modes of operation. INMODE selects between the two input analog control voltages. FMODE selects whether the PMU forces a voltage or a current. MMODE selects whether the DUT current or DUT voltage is directed to MSR_. HI-ZFORCE places the driver amplifier in a high-output-impedance state. Table 5 describes the various force and measure modes of operation.

Table 4. PMU Operation Using Control and Address Bits

BIT	BIT (3:2)		(1:0)	DIVILA ODEDATION	DMIL D ODEDATION		
A2	A1	C2	C1	PMU-A OPERATION	PMU-B OPERATION		
0	0	0	0	NOP: data just passes through			
0	0	0	1	Transfer PMU register A from input register A.	NOP.		
0	0	1	0	NOP.	Transfer PMU register B from input register B.		
0	0	1	1	Transfer PMU register A from input register A.	Transfer PMU register B from input register B.		
0	1	0	0	Transfer input register A from shift register.	NOP.		
0	1	0	1	Transfer input register A and PMU register A from shift register.	NOP.		
0	1	1	0	Transfer input register A from shift register.	Transfer PMU register B from input register B.		
0	1	1	1	Transfer input register A and PMU register A from shift register.	Transfer PMU register B from input register B.		
1	0	0	0	NOP.	Transfer input register B from shift register.		
1	0	0	1	Transfer PMU register A from input register A.	Transfer input register B from shift register.		
1	0	1	0	NOP.	Transfer input register B and PMU register B from shift register.		
1	0	1	1	Transfer PMU register A from input register A.	Transfer input register B and PMU register B from shift register.		
1	1	0	0	Transfer input register A from shift register.	Transfer input register B from shift register.		
1	1	0	1	Transfer input register A and PMU register A from shift register.	Transfer input register B from shift register.		
1	1	1	0	Transfer input register A from shift register.	Transfer input register B and PMU register B from shift register.		
1	1	1	1	Transfer input register A and PMU register A from shift register.	Transfer input register B and PMU register B from shift register.		

Table 5. PMU Force-Measure Mode Selection

(BIT 15) IN MODE*	(BIT 14) F MODE	(BIT 13) M MODE	(BIT 8) HI-ZFORCE	PMU MODE	FORCE OUTPUT	MEASURE OUTPUT	ACTIVE INPUT
0	0	1	1	FVMI	Voltage	I _{DUT}	V _{IN0}
1	0	1	1	FVMI	Voltage	IDUT	V _{IN1}
0	0	0	1	FVMV	Voltage	V _{DUT}	V _{INO}
1	0	0	1	FVMV	Voltage	V _{DUT}	V _{IN1}
0	1	1	1	FIMI	Current	IDUT	VINO
1	1	1	1	FIMI	Current	IDUT	V _{IN1}
0	1	0	1	FIMV	Current	V _{DUT}	VINO
1	1	0	1	FIMV	Current	V _{DUT}	V _{IN1}
Χ	0	1	0	FNMI (range E only)	High- Impedance	I _{DUT}	X
Х	0	0	0	FNMV	High- Impedance	V _{DUT}	X
0	1	0	0	Termination	Voltage	V _{DUT}	VINO
1	1	0	0	Termination	Voltage	V _{DUT}	V _{IN1}
0	1	1	0	Termination	Voltage	IDUT	VINO
1	1	1	0	Termination	Voltage	I _{DUT}	V _{IN1}

^{*}INSEL = 0

Table 6. Current-Range Selection

(BIT 12) RS2	(BIT 11) RS1	(BIT 10) RS0	RANGE	NOMINAL RESISTOR VALUE (Ω)
0	0	Χ	±2µA	R_E = 500k
0	1	0	±20μΑ	$R_D = 50k$
0	1	1	±200µA	R_C = 5k
1	0	0	±2mA	R_B = 500
1	Χ	1	±64mA	R_A = 15.6
1	1	0	External	_

Table 7. MSR_ Output Truth Table

(BIT 7) HI-ZMSR	HI-Z_	MSR_
1	1	Measure output enabled
0	1	High-Impedance
1	0	High-Impedance
0	0	High-Impedance

Current-Range Selection

Three bits from the control word, RS0, RS1, and RS2, control the full-scale current range for either FI (force current) or MI (measure current). Table 6 describes the full-scale current-range control.

Clamp Enable

The CLENABLE bit enables the force-output-voltage clamps when high and disables the clamps when low. There is hysteresis equal to approximately 5% of the current range for clamp.

Measure Output High-Impedance Control

MSR_ attains a low-leakage, high-impedance state by using the $\overline{\text{HI-ZMSR}}$ control bit, or the $\overline{\text{HI-Z}}$ input. $\overline{\text{HI-Z}}$ is internally pulled up to V_L with a 1.5M Ω resistor. The 2 bits are logically ANDed together to control the MSR_ output. $\overline{\text{HI-Z}}$ allows external multiplexing among several PMU MSR_ outputs without using the serial interface. Table 7 explains the various output modes for the MSR_ output.

Digital Output (DOUT)

The digital output follows the last output of the serial-shift register and clocks out on the falling edge of SCLK. DOUT serially shifts the first bit of the incoming serial data word 16.5 clock cycles later. This allows for daisy-chaining additional devices using DOUT and the same clock.

"Quick Load" Using Chip Select

If $\overline{\text{CS}}$ goes low and then returns high without any clock activity, the data from the input registers latch into the PMU registers. This extra function is not standard for SPI/QSPI/MICROWIRE interfaces. The quick load mimics the function of $\overline{\text{LOAD}}$ without forcing $\overline{\text{LOAD}}$ low.

Comparators

Two comparators configured as a window comparator monitor MSR_. THMAX_ and THMIN_ set the high and low thresholds that determine the window. Both outputs are open drain and share a single disable control that places the outputs in a high-impedance, low-leakage state. Table 8 describes the comparator output states of the MAX9951/MAX9952.

Applications Information

In force-voltage (FV) mode, the voltage at FORCE_ is directly proportional to the input control voltage. In force-current (FI) mode, the current flowing out of FORCE_ is proportional to the input control voltage. Positive current flows out of the PMU.

In force-nothing (FN) mode, FORCE_ is high impedance. In measure-current (MI) mode, the voltage at MSR_ is directly proportional to the current exiting FORCE_. Positive current flows out of the PMU.

In measure-voltage (MV) mode, the voltage at MSR_ is directly proportional to the voltage at SENSE_.

Current-Sense-Amplifier Offset-Voltage Input

IOS is a buffered input to the current-sense amplifiers. The current-sense amplifiers convert the input control voltage (INO_ or IN1_) to the forced DUT current (FI),

Table 8. Comparator Truth Table

(BIT 6) DISABLE	CONDITION	DUTH	DUTL
0	Χ	High-Z	High-Z
1	V _{MSR} > V _{THMAX} and V _{THMIN}	0	1
1	VTHMAX > VMSR > VTHMIN	1	1
1	V _{THMAX} and V _{THMIN} > V _{MSR}	1	0
1	VTHMIN > VMSR > VTHMAX*	0	0

^{*}V_{THMAX} > V_{THMIN} constitutes normal operation. This condition, however, has V_{THMIN} > V_{THMAX} and does not cause any problems with the operation of the comparators.

and convert the sensed DUT current to the MSR_ output voltage (MI). When IOS equals zero relative to DUTGND (the GND voltage at the DUT, which the level-setting DACs and the ADC are presumed to use as a ground reference), the nominal voltage range that corresponds to ±full-scale current is -4V to +4V. Any voltage applied to IOS adds directly to this control input/measure output voltage range, i.e., applying +4V to IOS forces the voltage range that corresponds to ±full-scale current from 0 to +8V.

The following equations determine the minimum and maximum currents for each current range corresponding to the input voltage or measure voltage:

Choose IOS so the limits of MSR_ do not go closer than 2.8V to either VEE or VCC. For example, with supplies of +10V and -5V, limit the MSR_ output to -2.2V and +7.2V. Therefore, set IOS between +1.8V and +3.2V. MSR_ could clip if IOS is not within this range. Use these general equations for the limits on IOS:

Minimum
$$V_{IOS} = V_{EE} + 6.8V$$

Maximum $V_{IOS} = V_{CC} - 6.8V$

Current Booster for Highest Current Range

An external buffer amplifier can be used to provide a current range greater than the MAX9951/MAX9952 maximum ±64mA output current (Figure 5). This function operates as follows:

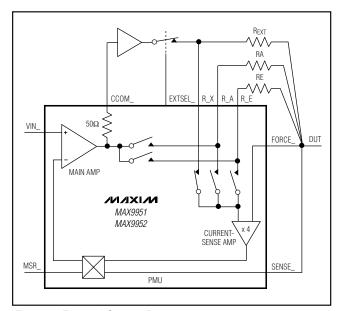


Figure 5. External Current Boost

A digital output decoded from the range select bits, EXTSEL_, indicates when to activate the booster. CCOM_ serves as an input to an external buffer through an internal 50Ω current-limit series resistor. Connect the external buffer output to the external current-sense resistor, REXT, and to R_X. Connect the other side of R_X to FORCE_. Ensure that the external switch is low leakage.

Voltage Clamps

The voltage clamps limit FORCE_ and operate over the entire specified current range. Set the clamp voltages externally at CLHI_ and CLLO_. The voltage at FORCE_ triggers the clamps independent of the voltage at SENSE_. When enabled, the clamps function in FI mode only. Use clamp voltages of 0.7V above and below the FORCE_ voltage range to ensure proper operation of the PMU.

Current Limit

The FORCE_ current-limiting circuitry, 92mA (maximum), ensures a well-behaved MSR_ output for currents between the full current range and the current limits. For currents greater than the full-scale current, the MSR_ voltage is greater than +4V, and for currents less than the full-scale current, the MSR_ voltage is less than -4V. Additionally, serial interface bit B2 enables a range-sensitive current limit of 2.5 times the nominal current range. Table 9 shows the current-limit operation.

Independent Control of the Feedback Switch and the Measure Switch

Two single-pole-double-throw (SPDT) switches determine the mode of operation of the PMU. One switch determines whether the sensed DUT current or DUT voltage feeds back to the input, and thus determines whether the MAX9951/MAX9952 force current or voltage. The other switch determines whether MSR_ senses the DUT current or DUT voltage.

Table 9. Current Limit

FMODE	RANGE	B2 (BIT 5)	CURRENT LIMIT
Х	Any	0	65mA to 92mA
0	А	1	65mA to 92mA
0	В	1	5mA
0	С	1	500μΑ
0	D	1	50μΑ
0	Е	1	5μΑ

Independent control of these switches and the HI-ZFORCE state permits flexible modes of operation beyond the traditional force-voltage/measure-current (FVMI) and force-current/measure-voltage (FIMV) modes. The MAX9951/MAX9952 support the following eight modes:

- FVMI
- FIMV
- FVMV
- FIMI
- FNMV
- FNMI (range E only)
- Terminate/Measure V
- Terminate/Measure I

Figure 6 shows the internal path structure for force-voltage/measure-current mode. In force-voltage/measure-current mode, the current across the appropriate external sense resistor (R_A to R_E) provides a voltage at MSR_. SENSE_ samples the voltage at the DUT and feeds the buffered result back to the negative input of the voltage amplifier. The voltage at MSR_ is proportional to the FORCE_ current in accordance with the following formula:

Figure 7 shows the internal path structure for the force-current/measure-voltage mode. In force-current/measure-voltage mode, the appropriate external sense resistor (R_A to R_E) provides a feedback voltage to

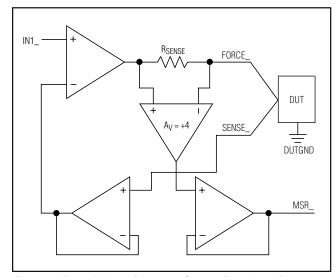


Figure 6. Force-Voltage/Measure-Current Functional Diagram

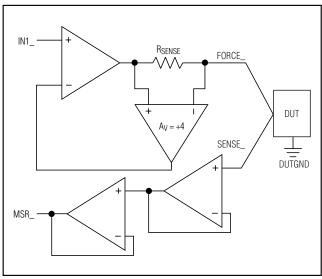


Figure 7. Force-Current/Measure-Voltage Functional Diagram

the inverting input of the voltage amplifier. SENSE_samples the voltage at the DUT and provides a buffered result at MSR.

High-Impedance States

The FORCE_, MSR_, and comparator outputs feature individual high-impedance control that places them into a high-impedance, low-leakage state. The high-impedance state allows busing of MSR_ and comparator outputs with other PMU measure and comparator outputs. The FORCE_ output high-impedance state allows for additional modes of operation as described in Table 5 and can eliminate the need for a series relay in some applications.

The FORCE_, MSR_, and comparator outputs power up in the high-impedance state.

Input Source Selection

Either one of two input signals, INO_ or IN1_, can control both the forced voltage and the forced current. In this case, the two input signals represent alternate forcing values that can be selected either with the serial interface or INSEL_. Alternatively, each input signal can be dedicated to control a single forcing function (i.e., voltage or current).

Short-Circuit Protection

FORCE_ and SENSE_ input can withstand a short to any voltage between the supply rails.

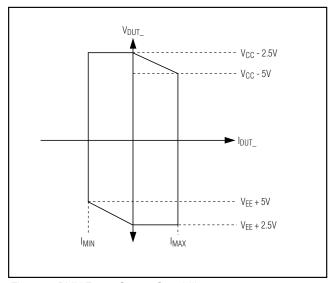


Figure 8. PMU Force-Output Capability

Mode and Range Change Transients

The MAX9951/MAX9952 feature make-before-break switching to minimize glitches. The integrated voltage clamps also reduce glitching at the output.

DUT Voltage Swing vs. DUT Current and Power-Supply Voltages

Several factors limit the actual DUT voltage that the PMU delivers:

- The overhead required by the device amplifiers and other integrated circuitry; this is typically 2.5V from each rail independent of load.
- The voltage drop across the current-range select resistor and internal circuitry in series with the sense resistor. At full current, the combined voltage drop is typically 2.5V.
- Variations in the power supplies.
- Variation of DUT ground vs. PMU ground.

Neglecting the effects of the third and fourth items, Figure 8 demonstrates the force-output capabilities of the PMU. For zero DUT current, the DUT voltage swings from (VEE + 2.5V) to (VCC - 2.5V). For larger positive DUT currents, the positive swing drops off linearly until it reaches (VCC - 5V) at full current. Similarly, for larger negative DUT currents, the negative voltage swing drops off linearly until it reaches (VEE + 5V) at full current.

Ground, DUT Ground, and IOS

The MAX9951/MAX9952 utilize two local grounds, AGND (analog ground) and DGND (digital ground). Connect AGND and DGND together on the PC board. In a typical ATE system, the PMU force voltage is relative to DUT ground. In this case, reference the input voltages INO_ and IN1_ to DUT ground. Similarly, reference IOS to DUT ground. If it is not desired to offset the current control and measure voltages, connect IOS to DUT ground potential.

Reference the MSR_ output to DUT ground.

Settling Times and Compensation Capacitors

The data in the *Electrical Characteristics* table reflects the circuit shown in the *Functional Diagram* that includes a single compensation capacitor (CX_) effectively across all the sense resistors. Placing individual capacitors, CRA, CRB, CRC, CRD, and CRE directly across the sense resistors, R_A, R_B, R_C, R_D, and R_E, independently optimizes each range.

The combination of the capacitance across the sense resistors, along with the main amplifier compensation comparator, CM_, ensures stability into the maximum expected load capacitance while optimizing settling time for a given load.

Digital Inputs (SCLK, DIN, CS, and LOAD)

The digital inputs incorporate hysteresis to mitigate issues with noise, as well as provide for compatibility with opto-isolators that can have slow edges.

Temperature Monitor

Each device supplies a single temperature output signal, TEMP, that asserts a nominal output voltage of 2.98V at a die temperature of +25°C (298K). The output voltage increases proportionately with temperature at a rate of 10mV/°C. The temperature sensor output impedance is $15\text{k}\Omega$ (typ). Determine the die temperature using:

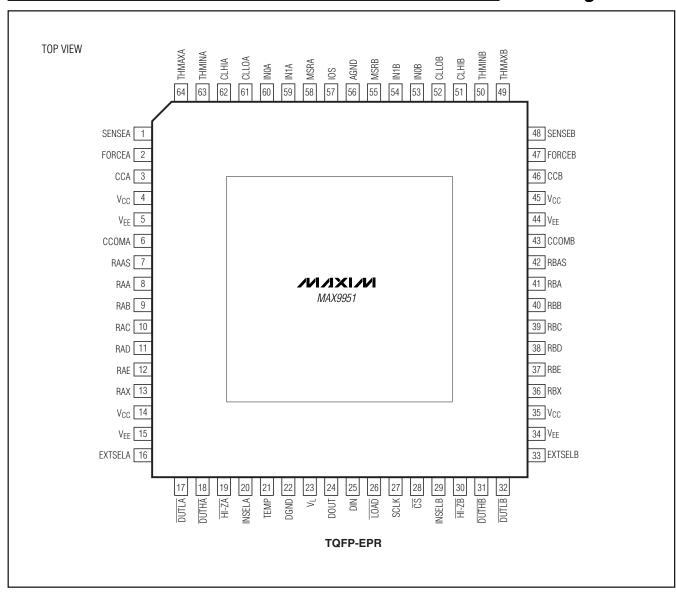
TDIE = (100) x VTEMP - 273 [°C]

Chip Information

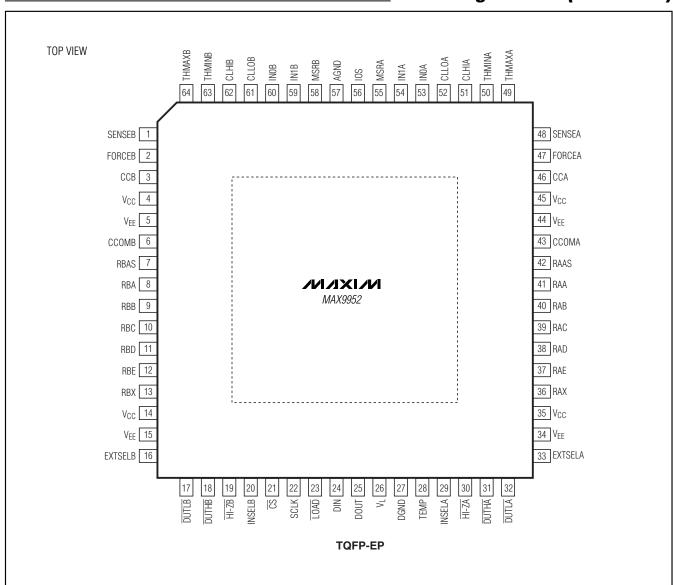
TRANSISTOR COUNT: 11,000

PROCESS: BICMOS

Pin Configurations



Pin Configurations (continued)



_Package Information

For the latest package outline information, go to **www.maxim-ic.com/packages**.

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